

# TPS92663-Q1 High-Brightness LED Matrix Manager for Automotive Headlight Systems

## 1 Features

- AEC-Q100 Qualified for Automotive Applications
  - Device Temperature Grade 1:  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $T_A$
  - Device HBM Classification Level: H1C
  - Device CDM Classification Level: C5
- Input Voltage Range: 4.5 V to 60 V
- Six Integrated Bypass Switches
  - Two Sub-Strings of Three Series Switches
  - 20 V (Maximum) Across Switch
  - 62 V (Maximum) Switch to GND
- Multi-Drop UART Communication Interface
  - Up to 16 Addressable Devices
  - Integrates on same bus with the TPS92662
- Compatible with CAN Physical Layer
  - Minimum Number of Wires in Cable Harness
- 8-bit ADC with Two MUX Inputs
- Crystal Oscillator Driver
- Programmable 10-bit PWM Dimming
  - Individual Phase Shift and Pulse Width
  - Device-to-device Synchronization
- LED Open and Short Detection and Protection

## 2 Applications

- Automotive headlight systems
- High-Brightness LED Matrix Systems
- ADB or Glare-Free High Beam

## 3 Description

The TPS92663-Q1 LED matrix manager device enables fully dynamic adaptive lighting solutions by providing individual pixel-level LED control.

The device includes two sub-strings of three series-connected integrated switches for bypassing individual LEDs. The individual sub-strings allow the device to accept either single or multiple current sources. It also allows a parallel connection of two switches to bypass high-current LEDs.

A master microcontroller may be used to control and manage the TPS92663-Q1 devices via a multi-drop universal asynchronous receiver transmitter (UART) serial interface. The serial interface supports the use of CAN transceivers for a more robust physical layer. An application can use the TPS92663-Q1 device and the TPS92662-Q1 device on the same bus.

An on-device, 8 bit ADC with two multiplexed inputs can be used for system temperature compensation and used to measure a binning value which allows for LED binning and coding.

The internal charge pump rail supplies the gate drive voltage for the LED bypass switches. The low on-resistance ( $R_{DS(on)}$ ) of the bypass switch minimizes conduction loss and power dissipation.

The phase shift and pulse width for each individual LED in the string are programmable. The device uses an internal register to adjust the PWM frequency. Multiple devices can be synchronized. The switch transitions during PWM dimming operation have a programmable slew rate to mitigate EMI concerns.

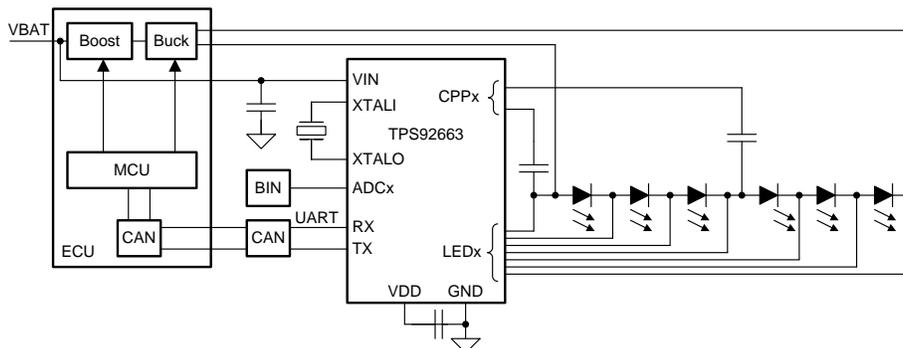
The device features open LED protection with programmable threshold. The serial interface reports open LED and short LED faults.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS92663-Q1	PWP (24)	7.70 mm x 4.40 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Simplified Application



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
July 2018	*	Initial release.

## 5 Device and Documentation Support

### 5.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 5.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 5.3 Trademarks

E2E is a trademark of Texas Instruments.

### 5.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 5.5 Glossary

**SLYZ022** — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 6 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TPS92663QPWPRQ1</a>	Active	Production	HTSSOP (PWP)   24	2000   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	TPS92663Q
TPS92663QPWPRQ1.A	Active	Production	HTSSOP (PWP)   24	2000   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	TPS92663Q
<a href="#">TPS92663QPWPTQ1</a>	Active	Production	HTSSOP (PWP)   24	250   SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	TPS92663Q
TPS92663QPWPTQ1.A	Active	Production	HTSSOP (PWP)   24	250   SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	TPS92663Q

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

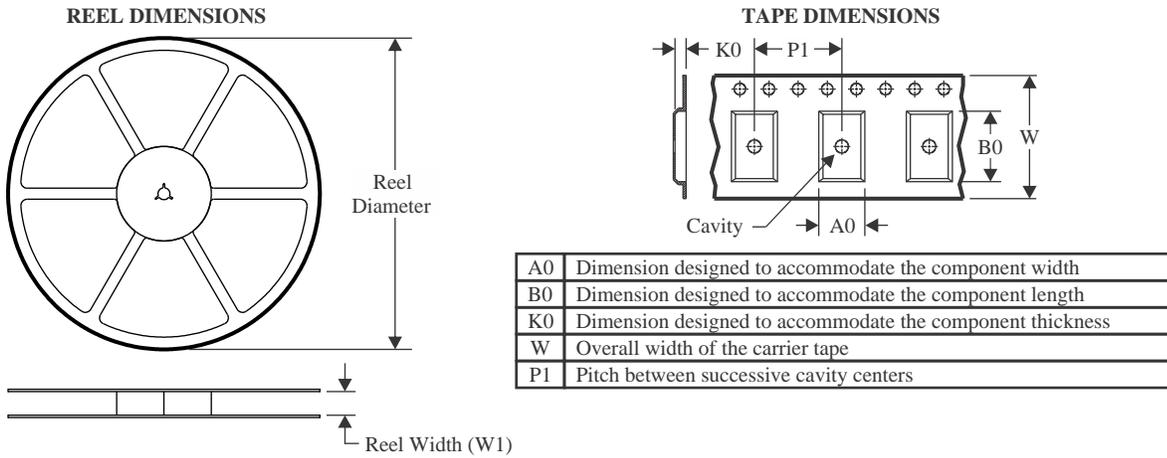
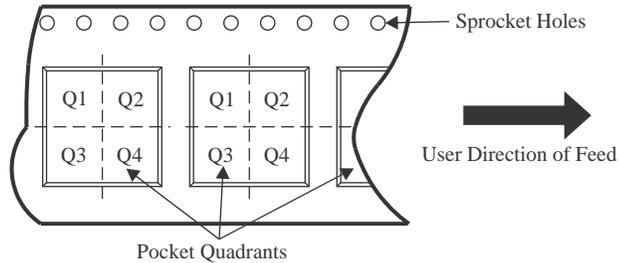
<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

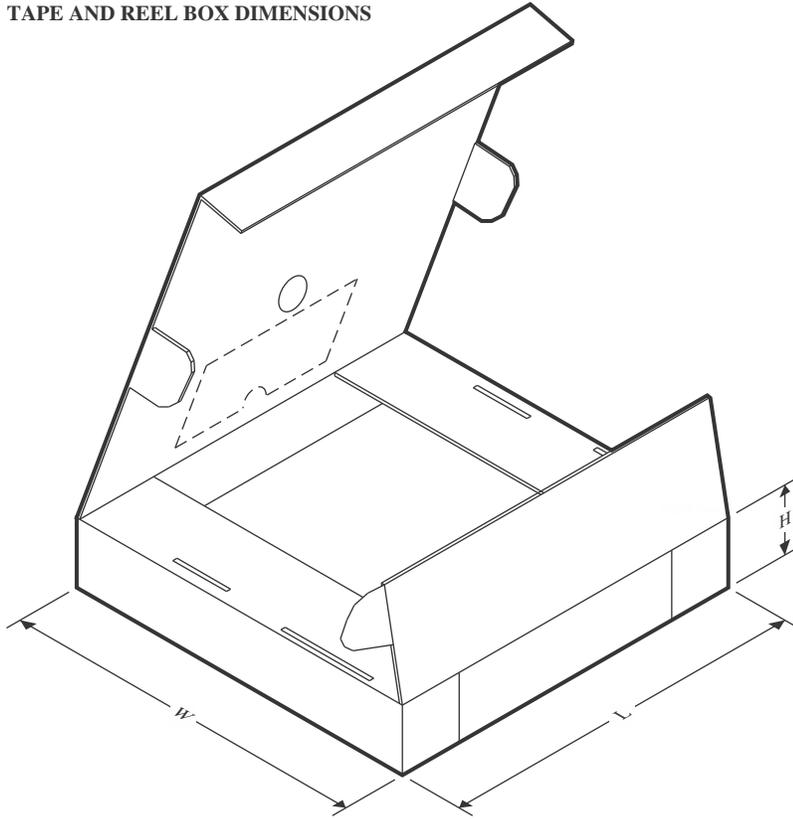
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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS92663QPWPRQ1	HTSSOP	PWP	24	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS92663QPWPRQ1	HTSSOP	PWP	24	2000	350.0	350.0	43.0

## GENERIC PACKAGE VIEW

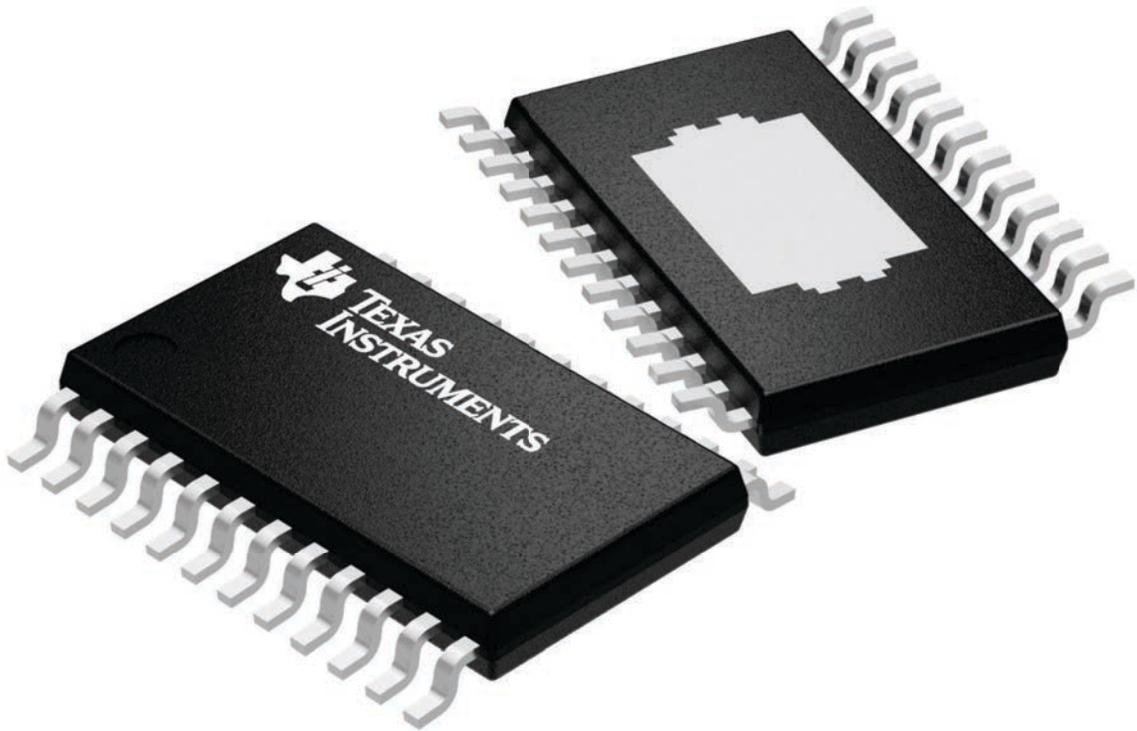
**PWP 24**

**PowerPAD™ TSSOP - 1.2 mm max height**

4.4 x 7.6, 0.65 mm pitch

PLASTIC SMALL OUTLINE

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



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Last updated 10/2025